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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI, SPI
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	16-DIP (0.300", 7.62mm)
Supplier Device Package	16-PDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mcl908qb8pe">https://www.e-xfl.com/product-detail/nxp-semiconductors/mcl908qb8pe</a>

## Chapter 11

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## Chapter 13

### LVIRSTD — LVI Reset Disable Bit

LVIRSTD disables the reset signal from the LVI module.

- 1 = LVI module resets disabled
- 0 = LVI module resets enabled

### LVIPWRD — LVI Power Disable Bit

LVIPWRD disables the LVI module.

- 1 = LVI module power disabled
- 0 = LVI module power enabled

### LVITRIP — LVI Trip Point Selection Bit

LVITRIP selects the voltage operating mode of the LVI module. The voltage mode selected for the LVI should match the operating  $V_{DD}$  for the LVI's voltage trip points for each of the modes.

- 1 = LVI operates for a 5-V protection
- 0 = LVI operates for a 3-V protection

#### NOTE

*The LVITRIP bit is cleared by a power-on reset (POR) only. Other resets will leave this bit unaffected.*

### SSREC — Short Stop Recovery Bit

SSREC enables the CPU to exit stop mode with a delay of 32 BUSCLKX4 cycles instead of a 4096 BUSCLKX4 cycle delay.

- 1 = Stop mode recovery after 32 BUSCLKX4 cycles
- 0 = Stop mode recovery after 4096 BUSCLKX4 cycles

#### NOTE

*Exiting stop mode by an LVI reset will result in the long stop recovery.*

When using the LVI during normal operation but disabling during stop mode, the LVI will have an enable time of  $t_{EN}$ . The system stabilization time for power-on reset and long stop recovery (both 4096 BUSCLKX4 cycles) gives a delay longer than the LVI enable time for these startup scenarios. There is no period where the MCU is not protected from a low-power condition. However, when using the short stop recovery configuration option, the 32 BUSCLKX4 delay must be greater than the LVI's turn on time to avoid a period in startup where the LVI is not protecting the MCU.

### STOP — STOP Instruction Enable Bit

STOP enables the STOP instruction.

- 1 = STOP instruction enabled
- 0 = STOP instruction treated as illegal opcode

### COPD — COP Disable Bit

COPD disables the COP module.

- 1 = COP module disabled
- 0 = COP module enabled

### 9.3.2 Keyboard Initialization

When a keyboard interrupt pin is enabled, it takes time for the internal pullup or pulldown device to pull the pin to its deasserted level. Therefore a false interrupt can occur as soon as the pin is enabled.

To prevent a false interrupt on keyboard initialization:

1. Mask keyboard interrupts by setting IMASKK in KBSCR.
2. Enable the KBI polarity by setting the appropriate KBIPx bits in KBIPR.
3. Enable the KBI pins by setting the appropriate KBIEx bits in KBIER.
4. Write to ACKK in KBSCR to clear any false interrupts.
5. Clear IMASKK.

An interrupt signal on an edge sensitive pin can be acknowledged immediately after enabling the pin. An interrupt signal on an edge and level sensitive pin must be acknowledged after a delay that depends on the external load.

## 9.4 Interrupts

The following KBI source can generate interrupt requests:

- Keyboard flag (KEYF) — The KEYF bit is set when any enabled KBI pin is asserted based on the KBI mode and pin polarity. The keyboard interrupt mask bit, IMASKK, is used to enable or disable KBI interrupt requests.

## 9.5 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power-consumption standby modes.

### 9.5.1 Wait Mode

The KBI module remains active in wait mode. Clearing IMASKK in KBSCR enables keyboard interrupt requests to bring the MCU out of wait mode.

### 9.5.2 Stop Mode

The KBI module remains active in stop mode. Clearing IMASKK in KBSCR enables keyboard interrupt requests to bring the MCU out of stop mode.

## 9.6 KBI During Break Interrupts

The system integration module (SIM) controls whether status bits in other modules can be cleared during the break state. The BCFE bit in the break flag control register (BFCR) enables software to clear status bits during the break state. See BFCR in the SIM section of this data sheet.

To allow software to clear status bits during a break interrupt, write a 1 to BCFE. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a 0 to BCFE. With BCFE cleared (its default state), software can read and write registers during the break state without affecting status bits. Some status bits have a two-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is cleared. After the break, doing the second step clears the status bit.

Figure 11-3 shows how BUSCLKX4 is derived from INTCLK and OSC2 can output BUSCLKX4 by setting OSC2EN.

### 11.3.2.1 Internal Oscillator Trimming

OSCTRIM allows a clock period adjustment of +127 and –128 steps. Increasing the OSCTRIM value increases the clock period, which decreases the clock frequency. Trimming allows the internal clock frequency to be fine tuned to the target frequency.

All devices are factory programmed with a trim value that is stored in FLASH memory at location \$FFC0. The trim value is not automatically loaded into the OSCTRIM register. User software must copy the trim value from \$FFC0 into OSCTRIM if needed. The factory trim value provides the accuracy required for communication using forced monitor mode. Some production programmers erase the factory trim value, so confirm with your programmer vendor that the trim value at \$FFC0 is preserved, or is re-trimmed. Trimming the device in the user application board will provide the most accurate trim value.

### 11.3.2.2 Internal to External Clock Switching

When external clock source (external OSC, RC, or XTAL) is desired, the user must perform the following steps:

1. For external crystal circuits only, configure OSCOPT[1:0] to external crystal. To help precharge an external crystal oscillator, momentarily configure OSC2 as an output and drive it high for several cycles. This can help the crystal circuit start more robustly.
2. Configure OSCOPT[1:0] and ECFS[1:0] according to [11.8.1 Oscillator Status and Control Register](#). The oscillator module control logic will then enable OSC1 as an external clock input and, if the external crystal option is selected, OSC2 will also be enabled as the clock output. If RC oscillator option is selected, enabling the OSC2 output may change the bus frequency.
3. Create a software delay to provide the stabilization time required for the selected clock source (crystal, resonator, RC). A good rule of thumb for crystal oscillators is to wait 4096 cycles of the crystal frequency; i.e., for a 4-MHz crystal, wait approximately 1 ms.
4. After the stabilization delay has elapsed, set ECGON.

After ECGON set is detected, the OSC module checks for oscillator activity by waiting two external clock rising edges. The OSC module then switches to the external clock. Logic provides a coherent transition. The OSC module first sets ECGST and then stops the internal oscillator.

### 11.3.2.3 External to Internal Clock Switching

After following the procedures to switch to an external clock source, it is possible to go back to the internal source. By clearing the OSCOPT[1:0] bits and clearing the ECGON bit, the external circuit will be disengaged. The bus clock will be derived from the selected internal clock source based on the ICFS[1:0] bits.

## 11.3.3 External Oscillator

The external oscillator option is designed for use when a clock signal is available in the application to provide a clock source to the MCU. The OSC1 pin is enabled as an input by the oscillator module. The clock signal is used directly to create BUSCLKX4 and also divided by two to create BUSCLKX2.

In this configuration, the OSC2 pin cannot output BUSCLKX4. The OSC2EN bit will be forced clear to enable alternative functions on the pin.

# 11.6 OSC During Break Interrupts

There are no status flags associated with the OSC module.

The system integration module (SIM) controls whether status bits in other modules can be cleared during the break state. The BCFE bit in the break flag control register (BFCR) enables software to clear status bits during the break state. See BFCR in the SIM section of this data sheet.

To allow software to clear status bits during a break interrupt, write a 1 to BCFE. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a 0 to BCFE. With BCFE cleared (its default state), software can read and write registers during the break state without affecting status bits. Some status bits have a two-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is cleared. After the break, doing the second step clears the status bit.

# 11.7 I/O Signals

The OSC shares its pins with general-purpose input/output (I/O) port pins. See [Figure 11-1](#) for port location of these shared pins.

## 11.7.1 Oscillator Input Pin (OSC1)

The OSC1 pin is an input to the crystal oscillator amplifier, an input to the RC oscillator circuit, or an input from an external clock source.

When the OSC is configured for internal oscillator, the OSC1 pin can be used as a general-purpose input/output (I/O) port pin or other alternative pin function.

## 11.7.2 Oscillator Output Pin (OSC2)

For the XTAL oscillator option, the OSC2 pin is the output of the crystal oscillator amplifier.

When the OSC is configured for internal oscillator, external clock, or RC, the OSC2 pin can be used as a general-purpose I/O port pin or other alternative pin function. When the oscillator is configured for internal or RC, the OSC2 pin can be used to output BUSCLKX4.

**Table 11-1. OSC2 Pin Function**

Option	OSC2 Pin Function
XTAL oscillator	Inverting OSC1
External clock	General-purpose I/O or alternative pin function
Internal oscillator or RC oscillator	Controlled by OSC2EN bit OSC2EN = 0: General-purpose I/O or alternative pin function OSC2EN = 1: BUSCLKX4 output

## Chapter 13

# Enhanced Serial Communications Interface (ESCI) Module

### 13.1 Introduction

The enhanced serial communications interface (ESCI) module allows asynchronous communications with peripheral devices and other microcontroller units (MCU).

The ESCI module shares its pins with general-purpose input/output (I/O) port pins. See [Figure 13-1](#) for port location of these shared pins. The ESCI baud rate clock source is controlled by a bit (ESCIBDSRC) located in the configuration register.

### 13.2 Features

Features include:

- Full-duplex operation
- Standard mark/space non-return-to-zero (NRZ) format
- Programmable baud rates
- Programmable 8-bit or 9-bit character length
- Separately enabled transmitter and receiver
- Separate receiver and transmitter interrupt requests
- Programmable transmitter output polarity
- Receiver wakeup methods
  - Idle line
  - Address mark
- Interrupt-driven operation with eight interrupt flags:
  - Transmitter empty
  - Transmission complete
  - Receiver full
  - Idle receiver input
  - Receiver overrun
  - Noise error
  - Framing error
  - Parity error
- Receiver framing error detection
- Hardware parity checking
- 1/16 bit-time noise detection

### 13.8.1 ESCI Control Register 1

ESCI control register 1 (SCC1):

- Enables loop mode operation
- Enables the ESCI
- Controls output polarity
- Controls character length
- Controls ESCI wakeup method
- Controls idle character detection
- Enables parity function
- Controls parity type

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	LOOPS	ENSCI	TXINV	M	WAKE	ILTY	PEN	PTY
Write:								
Reset:	0	0	0	0	0	0	0	0

**Figure 13-9. ESCI Control Register 1 (SCC1)**

#### LOOPS — Loop Mode Select Bit

This read/write bit enables loop mode operation. In loop mode the RxD pin is disconnected from the ESCI, and the transmitter output goes into the receiver input. Both the transmitter and the receiver must be enabled to use loop mode.

- 1 = Loop mode enabled
- 0 = Normal operation enabled

#### ENSCI — Enable ESCI Bit

This read/write bit enables the ESCI and the ESCI baud rate generator. Clearing ENSCI sets the SCTE and TC bits in ESCI status register 1 and disables transmitter interrupts.

- 1 = ESCI enabled
- 0 = ESCI disabled

#### TXINV — Transmit Inversion Bit

This read/write bit reverses the polarity of transmitted data.

- 1 = Transmitter output inverted
- 0 = Transmitter output not inverted

#### NOTE

*Setting the TXINV bit inverts all transmitted values including idle, break, start, and stop bits.*

#### M — Mode (Character Length) Bit

This read/write bit determines whether ESCI characters are eight or nine bits long (see [Table 13-4](#)). The ninth bit can serve as a receiver wakeup signal or as a parity bit.

- 1 = 9-bit ESCI characters
- 0 = 8-bit ESCI characters



Table 13-4. Character Format Selection

Control Bits		Character Format				
M	PEN:PTY	Start Bits	Data Bits	Parity	Stop Bits	Character Length
0	0 X	1	8	None	1	10 bits
1	0 X	1	9	None	1	11 bits
0	1 0	1	7	Even	1	10 bits
0	1 1	1	7	Odd	1	10 bits
1	1 0	1	8	Even	1	11 bits
1	1 1	1	8	Odd	1	11 bits

#### WAKE — Wakeup Condition Bit

This read/write bit determines which condition wakes up the ESCI: a 1 (address mark) in the MSB position of a received character or an idle condition on the Rx/D pin.

- 1 = Address mark wakeup
- 0 = Idle line wakeup

#### ILTY — Idle Line Type Bit

This read/write bit determines when the ESCI starts counting 1s as idle character bits. The counting begins either after the start bit or after the stop bit. If the count begins after the start bit, then a string of 1s preceding the stop bit may cause false recognition of an idle character. Beginning the count after the stop bit avoids false idle character recognition, but requires properly synchronized transmissions.

- 1 = Idle character bit count begins after stop bit
- 0 = Idle character bit count begins after start bit

#### PEN — Parity Enable Bit

This read/write bit enables the ESCI parity function (see Table 13-4). When enabled, the parity function inserts a parity bit in the MSB position (see Table 13-2).

- 1 = Parity function enabled
- 0 = Parity function disabled

#### PTY — Parity Bit

This read/write bit determines whether the ESCI generates and checks for odd parity or even parity (see Table 13-4).

- 1 = Odd parity
- 0 = Even parity

#### NOTE

*Changing the PTY bit in the middle of a transmission or reception can generate a parity error.*

### 13.8.2 ESCI Control Register 2

ESCI control register 2 (SCC2):

- Enables these interrupt requests:
  - SCTE bit to generate transmitter interrupt requests
  - TC bit to generate transmitter interrupt requests
  - SCRF bit to generate receiver interrupt requests
  - IDLE bit to generate receiver interrupt requests
- Enables the transmitter

## Enhanced Serial Communications Interface (ESCI) Module

- Enables the receiver
- Enables ESCI wakeup
- Transmits ESCI break characters

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	SCTIE	TCIE	SCRIE	ILIE	TE	RE	RWU	SBK
Write:								
Reset:	0	0	0	0	0	0	0	0

**Figure 13-10. ESCI Control Register 2 (SCC2)**

### SCTIE — ESCI Transmit Interrupt Enable Bit

This read/write bit enables the SCTE bit to generate ESCI transmitter interrupt requests. Setting the SCTIE bit in SCC2 enables the SCTE bit to generate interrupt requests.

- 1 = SCTE enabled to generate interrupt
- 0 = SCTE not enabled to generate interrupt

### TCIE — Transmission Complete Interrupt Enable Bit

This read/write bit enables the TC bit to generate ESCI transmitter interrupt requests.

- 1 = TC enabled to generate interrupt requests
- 0 = TC not enabled to generate interrupt requests

### SCRIE — ESCI Receive Interrupt Enable Bit

This read/write bit enables the SCRF bit to generate ESCI receiver interrupt requests. Setting the SCRIE bit in SCC2 enables the SCRF bit to generate interrupt requests.

- 1 = SCRF enabled to generate interrupt
- 0 = SCRF not enabled to generate interrupt

### ILIE — Idle Line Interrupt Enable Bit

This read/write bit enables the IDLE bit to generate ESCI receiver interrupt requests.

- 1 = IDLE enabled to generate interrupt requests
- 0 = IDLE not enabled to generate interrupt requests

### TE — Transmitter Enable Bit

Setting this read/write bit begins the transmission by sending a preamble of 10 or 11 1s from the transmit shift register to the TxD pin. If software clears the TE bit, the transmitter completes any transmission in progress before the TxD returns to the idle condition (high). Clearing and then setting TE during a transmission queues an idle character to be sent after the character currently being transmitted.

- 1 = Transmitter enabled
- 0 = Transmitter disabled

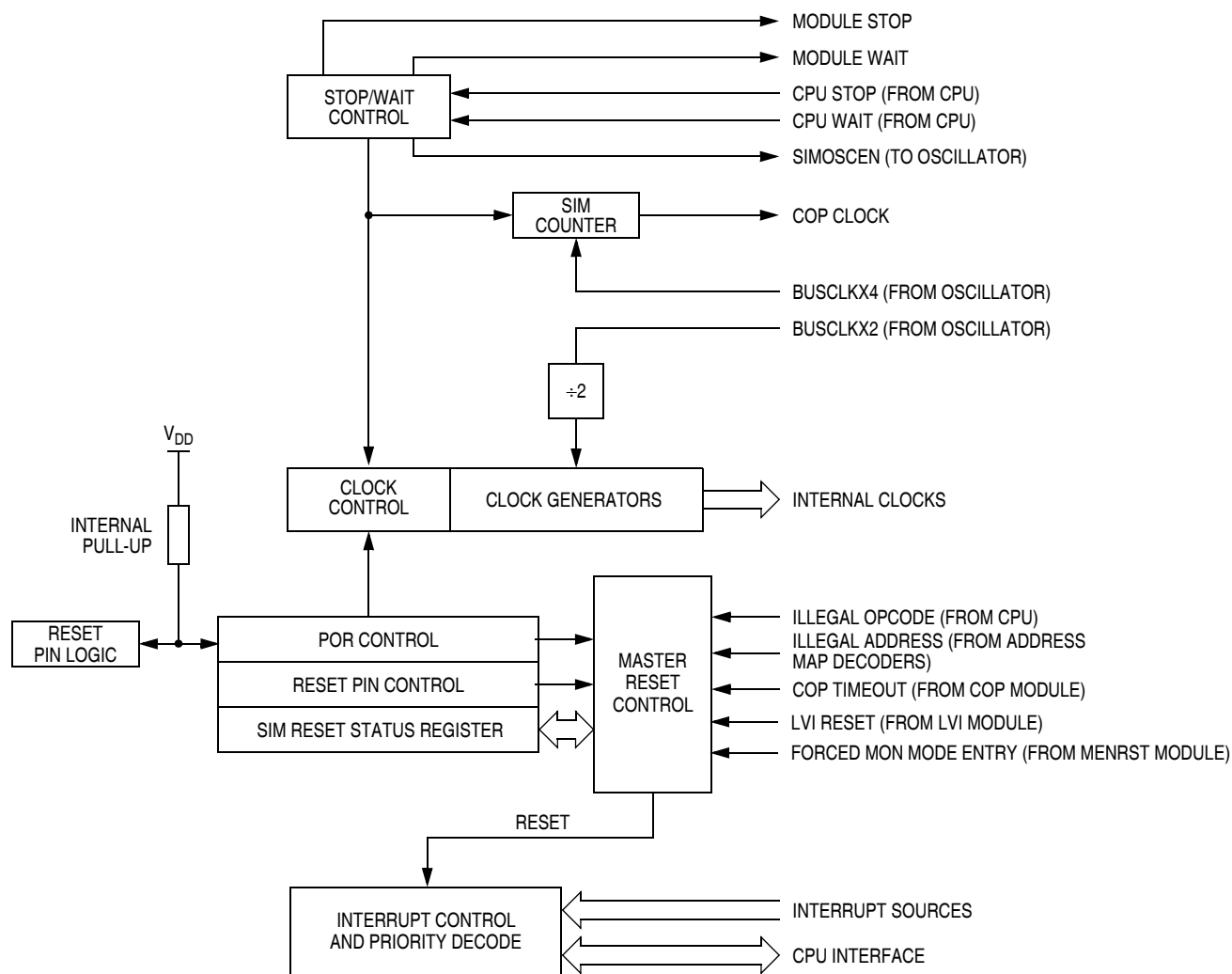
### NOTE

*Writing to the TE bit is not allowed when the enable ESCI bit (ENSCI) is clear. ENSCI is in ESCI control register 1.*

### RE — Receiver Enable Bit

Setting this read/write bit enables the receiver. Clearing the RE bit disables the receiver but does not affect receiver interrupt flag bits.

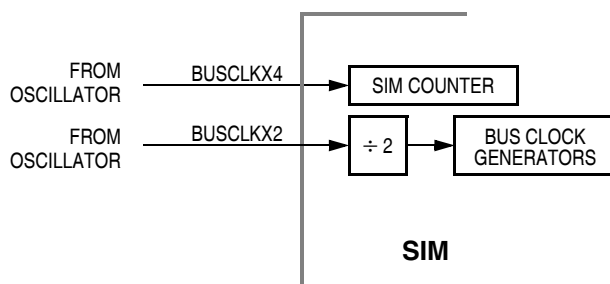
- 1 = Receiver enabled
- 0 = Receiver disabled



**Figure 14-1. SIM Block Diagram**

## 14.3 SIM Bus Clock Control and Generation

The bus clock generator provides system clock signals for the CPU and peripherals on the MCU. The system clocks are generated from an incoming clock, **BUSCLKX2**, as shown in [Figure 14-2](#).



**Figure 14-2. SIM Clock Signals**

## 14.6 Exception Control

Normal sequential program execution can be changed in three different ways:

1. Interrupts
  - a. Maskable hardware CPU interrupts
  - b. Non-maskable software interrupt instruction (SWI)
2. Reset
3. Break interrupts

### 14.6.1 Interrupts

An interrupt temporarily changes the sequence of program execution to respond to a particular event. [Figure 14-7](#) flow charts the handling of system interrupts.

Interrupts are latched, and arbitration is performed in the SIM at the start of interrupt processing. The arbitration result is a constant that the CPU uses to determine which vector to fetch. Once an interrupt is latched by the SIM, no other interrupt can take precedence, regardless of priority, until the latched interrupt is serviced (or the I bit is cleared).

At the beginning of an interrupt, the CPU saves the CPU register contents on the stack and sets the interrupt mask (I bit) to prevent additional interrupts. At the end of an interrupt, the RTI instruction recovers the CPU register contents from the stack so that normal processing can resume. [Figure 14-8](#) shows interrupt entry timing. [Figure 14-9](#) shows interrupt recovery timing.

#### 14.6.1.1 Hardware Interrupts

A hardware interrupt does not stop the current instruction. Processing of a hardware interrupt begins after completion of the current instruction. When the current instruction is complete, the SIM checks all pending hardware interrupts. If interrupts are not masked (I bit clear in the condition code register), and if the corresponding interrupt enable bit is set, the SIM proceeds with interrupt processing; otherwise, the next instruction is fetched and executed.

If more than one interrupt is pending at the end of an instruction execution, the highest priority interrupt is serviced first. [Figure 14-10](#) demonstrates what happens when two interrupts are pending. If an interrupt is pending upon exit from the original interrupt service routine, the pending interrupt is serviced before the LDA instruction is executed.

The LDA opcode is prefetched by both the INT1 and INT2 return-from-interrupt (RTI) instructions. However, in the case of the INT1 RTI prefetch, this is a redundant operation.

#### NOTE

*To maintain compatibility with the M6805 Family, the H register is not pushed on the stack during interrupt entry. If the interrupt service routine modifies the H register or uses the indexed addressing mode, software should save the H register and then restore it prior to exiting the routine.*

### 14.6.2.1 Interrupt Status Register 1

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	IF6	IF5	IF4	IF3	0	IF1	0	0
Write:	R	R	R	R	R	R	R	R
Reset:	0	0	0	0	0	0	0	0

R = Reserved

**Figure 14-11. Interrupt Status Register 1 (INT1)**

#### IF1 and IF3–IF6 — Interrupt Flags

These flags indicate the presence of interrupt requests from the sources shown in [Table 14-3](#).

1 = Interrupt request present

0 = No interrupt request present

**Bit 0, 1, and 3— Always read 0**

### 14.6.2.2 Interrupt Status Register 2

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	IF14	IF13	IF12	IF11	IF10	IF9	IF8	IF7
Write:	R	R	R	R	R	R	R	R
Reset:	0	0	0	0	0	0	0	0

R = Reserved

**Figure 14-12. Interrupt Status Register 2 (INT2)**

#### IF7–IF14 — Interrupt Flags

This flag indicates the presence of interrupt requests from the sources shown in [Table 14-3](#).

1 = Interrupt request present

0 = No interrupt request present

### 14.6.2.3 Interrupt Status Register 3

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	IF22	IF21	IF20	IF19	IF18	IF17	IF16	IF15
Write:	R	R	R	R	R	R	R	R
Reset:	0	0	0	0	0	0	0	0

R = Reserved

**Figure 14-13. Interrupt Status Register 3 (INT3)**

#### IF15–IF22 — Interrupt Flags

These flags indicate the presence of interrupt requests from the sources shown in [Table 14-3](#).

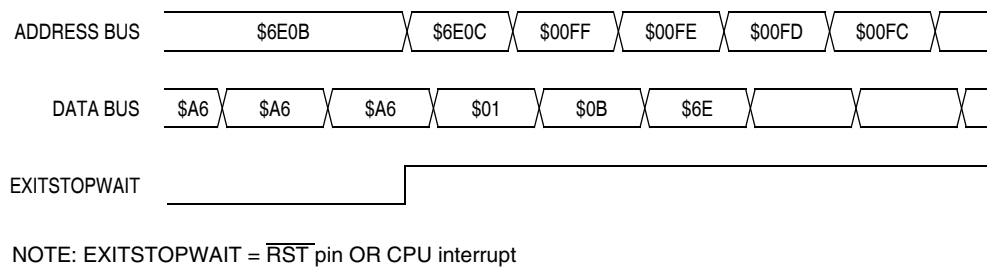
1 = Interrupt request present

0 = No interrupt request present

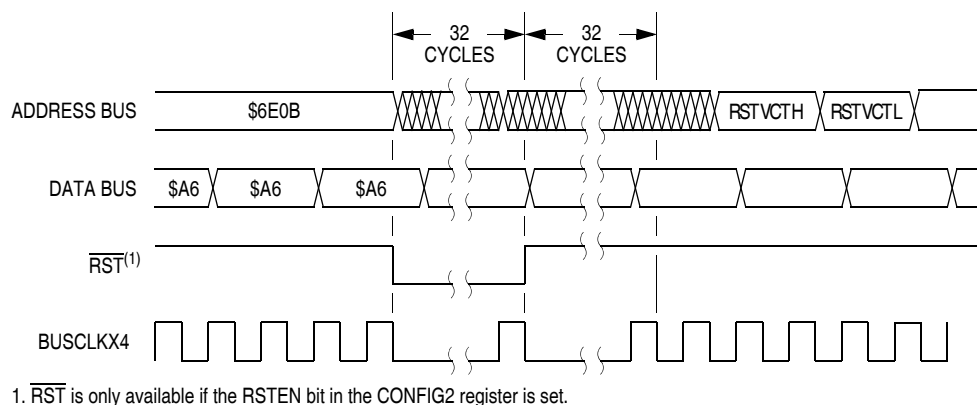
In wait mode, the CPU clocks are inactive. Refer to the wait mode subsection of each module to see if the module is active or inactive in wait mode. Some modules can be programmed to be active in wait mode.

Wait mode can also be exited by a reset (or break in emulation mode). A break interrupt during wait mode sets the SIM break stop/wait bit, SBSW, in the break status register (BSR). If the COP disable bit, COPD, in the configuration register is 0, then the computer operating properly module (COP) is enabled and remains active in wait mode.

Figure 14-15 and Figure 14-16 show the timing for wait recovery.



**Figure 14-15. Wait Recovery from Interrupt**



**Figure 14-16. Wait Recovery from Internal Reset**

### 14.7.2 Stop Mode

In stop mode, the SIM counter is reset and the system clocks are disabled. An interrupt request from a module can cause an exit from stop mode. Stacking for interrupts begins after the selected stop recovery time has elapsed. Reset or break also causes an exit from stop mode.

The SIM disables the oscillator signals (BUSCLKX2 and BUSCLKX4) in stop mode, stopping the CPU and peripherals. If OSCENINSTOP is set, BUSCLKX4 will remain running in STOP and can be used to run the AWU. Stop recovery time is selectable using the SSREC bit in the configuration register 1 (CONFIG1). If SSREC is set, stop recovery is reduced from the normal delay of 4096 BUSCLKX4 cycles down to 32. This is ideal for the internal oscillator, RC oscillator, and external oscillator options which do not require long start-up times from stop mode.

#### NOTE

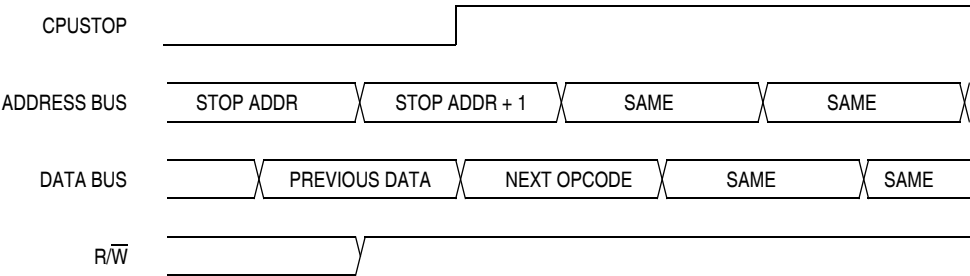
*External crystal applications should use the full stop recovery time by clearing the SSREC bit.*

## System Integration Module (SIM)

The SIM counter is held in reset from the execution of the STOP instruction until the beginning of stop recovery. It is then used to time the recovery period. [Figure 14-17](#) shows stop mode entry timing and [Figure 14-18](#) shows the stop mode recovery time from interrupt or break

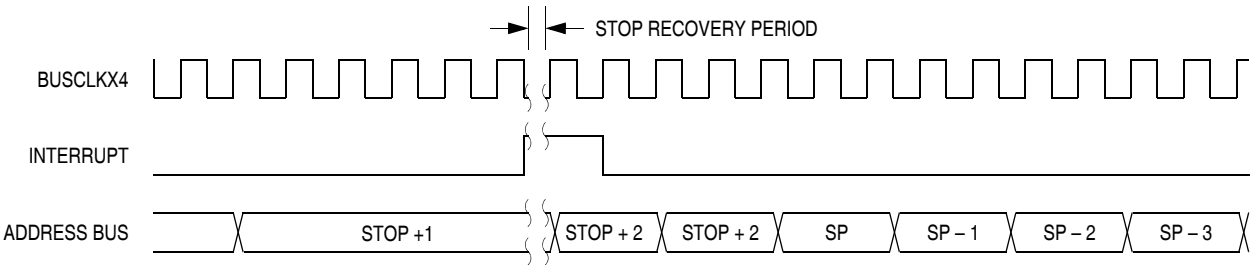
### NOTE

*To minimize stop current, all pins configured as inputs should be driven to a logic 1 or logic 0.*



NOTE: Previous data can be operand data or the STOP opcode, depending on the last instruction.

**Figure 14-17. Stop Mode Entry Timing**



**Figure 14-18. Stop Mode Recovery from Interrupt**

## 14.8 SIM Registers

The SIM has two memory mapped registers.

### 14.8.1 SIM Reset Status Register

The SRSR register contains flags that show the source of the last reset. The status register will automatically clear after reading SRSR. A power-on reset sets the POR bit and clears all other bits in the register. All other reset sources set the individual flag bits but do not clear the register. More than one reset source can be flagged at any time depending on the conditions at the time of the internal or external reset. For example, the POR and LVI bit can both be set if the power supply has a slow rise time.

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	POR	PIN	COP	ILOP	ILAD	MODRST	LVI	0
Write:								
POR:	1	0	0	0	0	0	0	0

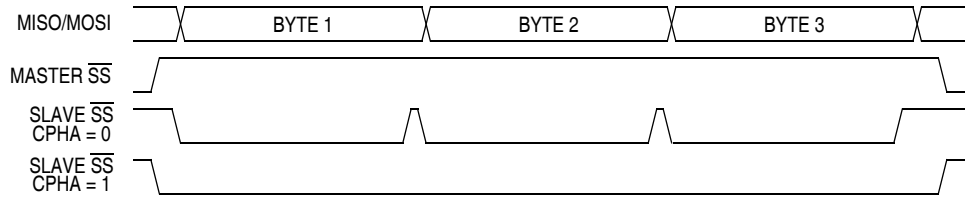
= Unimplemented

**Figure 14-19. SIM Reset Status Register (SRSR)**





## Serial Peripheral Interface (SPI) Module



**Figure 15-12. CPHA/SS Timing**

When an SPI is configured as a slave, the  $\overline{SS}$  pin is always configured as an input. It cannot be used as a general-purpose I/O regardless of the state of the MODFEN control bit. However, the MODFEN bit can still prevent the state of  $\overline{SS}$  from creating a MODF error. See [15.8.2 SPI Status and Control Register](#).

**NOTE**

*A high on the  $\overline{SS}$  pin of a slave SPI puts the MISO pin in a high-impedance state. The slave SPI ignores all incoming SPSCCK clocks, even if it was already in the middle of a transmission.*

When an SPI is configured as a master, the  $\overline{SS}$  input can be used in conjunction with the MODF flag to prevent multiple masters from driving MOSI and SPSCCK. (See [15.3.6.2 Mode Fault Error](#).) For the state of the  $\overline{SS}$  pin to set the MODF flag, the MODFEN bit in the SPSCCK register must be set. If the MODFEN bit is 0 for an SPI master, the  $\overline{SS}$  pin can be used as a general-purpose I/O under the control of the data direction register of the shared I/O port. When MODFEN is 1, it is an input-only pin to the SPI regardless of the state of the data direction register of the shared I/O port.

User software can read the state of the  $\overline{SS}$  pin by configuring the appropriate pin as an input and reading the port data register. See [Table 15-2](#).

**Table 15-2. SPI Configuration**

SPE	SPMSTR	MODFEN	SPI Configuration	Function of $\overline{SS}$ Pin
0	X <sup>(1)</sup>	X	Not enabled	General-purpose I/O; $\overline{SS}$ ignored by SPI
1	0	X	Slave	Input-only to SPI
1	1	0	Master without MODF	General-purpose I/O; $\overline{SS}$ ignored by SPI
1	1	1	Master with MODF	Input-only to SPI

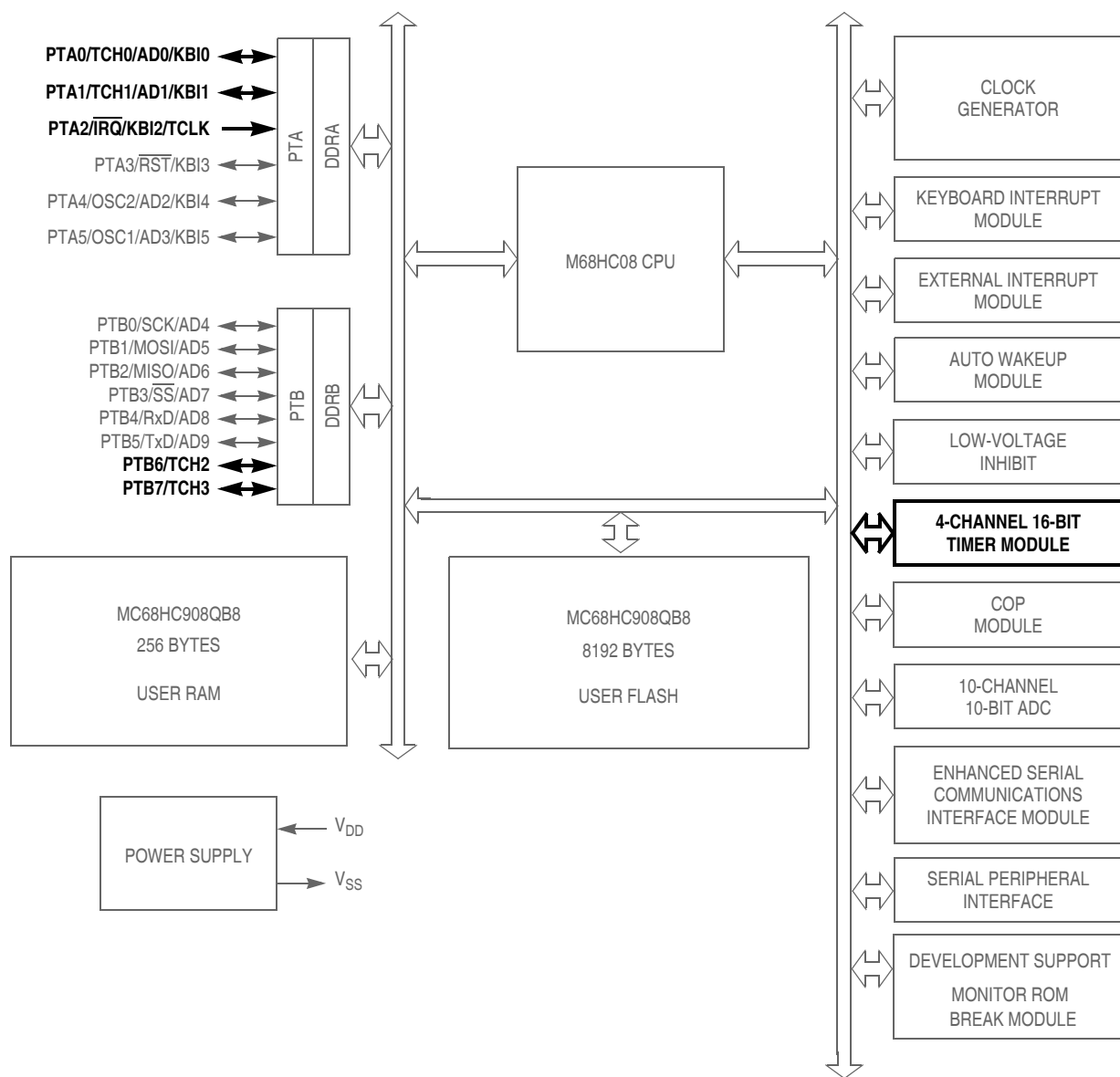
1. X = Don't care

## 15.8 Registers

The following registers allow the user to control and monitor SPI operation:

- SPI control register (SPCR)
- SPI status and control register (SPSCR)
- SPI data register (SPDR)

## Timer Interface Module (TIM)



$\overline{RST}$ ,  $\overline{IRQ}$ : Pins have internal pull up device  
 All port pins have programmable pull up device  
 PTA[0:5]: Higher current sink and source capability

**Figure 16-1. Block Diagram Highlighting TIM Block and Pins**

### 16.3.2 Input Capture

With the input capture function, the TIM can capture the time at which an external event occurs. When an active edge occurs on the pin of an input capture channel, the TIM latches the contents of the counter into the TIM channel registers, TCHxH:TCHxL. The polarity of the active edge is programmable. Input captures can be enabled to generate interrupt requests.



### BCFE — Break Clear Flag Enable Bit

This read/write bit enables software to clear status bits by accessing status registers while the MCU is in a break state. To clear status bits during the break state, the BCFE bit must be set.

- 1 = Status bits clearable during break
- 0 = Status bits not clearable during break

### 17.2.3 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power-consumption standby modes. If enabled, the break module will remain enabled in wait and stop modes. However, since the internal address bus does not increment in these modes, a break interrupt will never be triggered.

## 17.3 Monitor Module (MON)

The monitor module allows debugging and programming of the microcontroller unit (MCU) through a single-wire interface with a host computer. Monitor mode entry can be achieved without use of the higher test voltage,  $V_{TST}$ , as long as vector addresses \$FFFE and \$FFFF are blank, thus reducing the hardware requirements for in-circuit programming.

Features include:

- Normal user-mode pin functionality
- One pin dedicated to serial communication between MCU and host computer
- Standard non-return-to-zero (NRZ) communication with host computer
- Standard communication baud rate (7200 @ 2-MHz bus frequency)
- Execution of code in random-access memory (RAM) or FLASH
- FLASH memory security feature<sup>(1)</sup>
- FLASH memory programming interface
- Use of external 9.8304 MHz oscillator to generate internal frequency of 2.4576 MHz
- Simple internal oscillator mode of operation (no external clock or high voltage)
- Monitor mode entry without high voltage,  $V_{TST}$ , if reset vector is blank (\$FFFE and \$FFFF contain \$FF)
- Normal monitor mode entry if  $V_{TST}$  is applied to  $\overline{IRQ}$

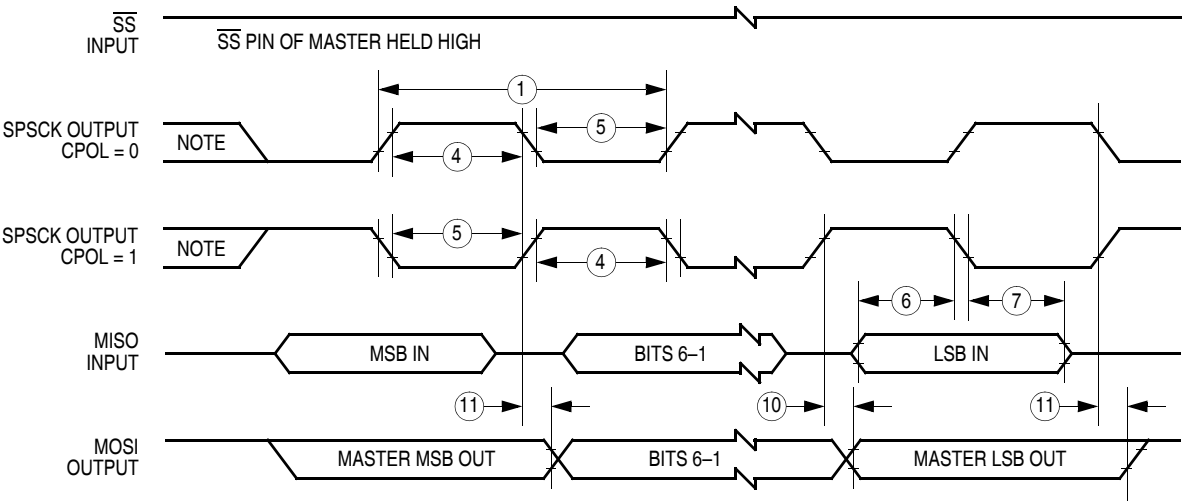
### 17.3.1 Functional Description

Figure 17-9 shows a simplified diagram of monitor mode entry.

The monitor module receives and executes commands from a host computer. Figure 17-10, Figure 17-11, and Figure 17-12 show example circuits used to enter monitor mode and communicate with a host computer via a standard RS-232 interface.

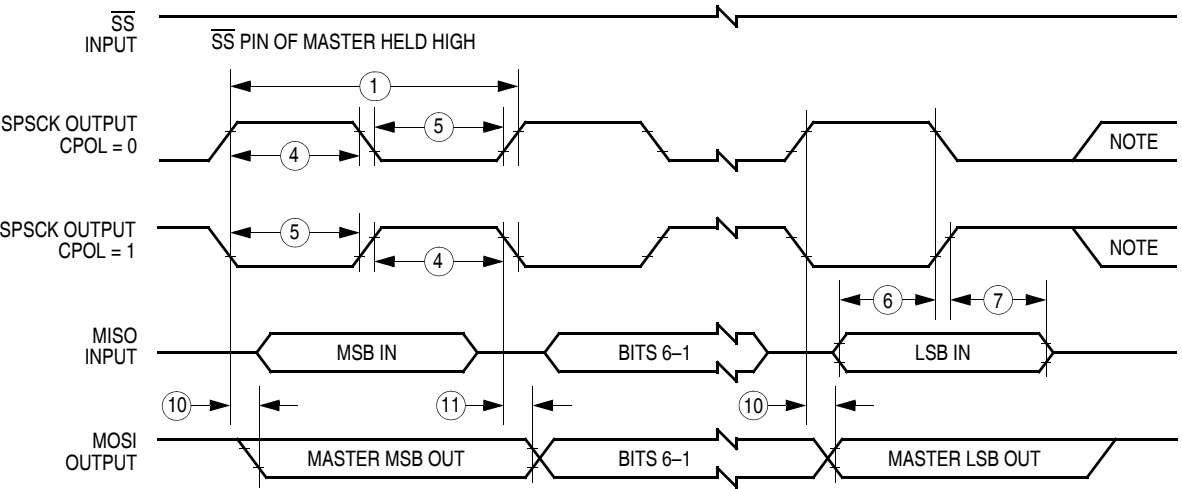
Simple monitor commands can access any memory address. In monitor mode, the MCU can execute code downloaded into RAM by a host computer while most MCU pins retain normal operating mode functions. All communication between the host computer and the MCU is through the PTA0 pin. A level-shifting and multiplexing interface is required between PTA0 and the host computer. PTA0 is used in a wired-OR configuration and requires a pullup resistor.

1. No security feature is absolutely secure. However, Freescale's strategy is to make reading or copying the FLASH difficult for unauthorized users.



Note: This first clock edge is generated internally, but is not seen at the SPSCK pin.

**a) SPI Master Timing (CPHA = 0)**



Note: This last clock edge is generated internally, but is not seen at the SPSCK pin.

**b) SPI Master Timing (CPHA = 1)**

**Figure 18-11. SPI Master Timing**